2057419-2 ACTIVE

IMPACT

TE Internal #: 2057419-2

60 Position, Mating Alignment, Guide Pin Mating Alignment Type, 6 Row, 10 Column, PCB Mount Header, Vertical, IMPACT, High

Speed Backplane Connectors

View on TE.com >



Connectors > PCB Connectors > Backplane Connectors > High Speed Backplane Connectors



Number of Positions: 60

Row-to-Row Spacing: 1.35 mm [.053 in]

Mating Alignment: With

Mating Alignment Type: Guide Pin

Number of Rows: 6

Features

Product Type Features

Signal Arrangement	Differential
Connector System	Board-to-Board
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Shroud Style	Partially Shrouded
Configuration Features	
Number of Ground Positions	20

Configuration realtires	
Number of Ground Positions	20
Number of Pairs	20
Stackable	No
Number of Signal Positions	40
Number of Positions	60
Number of Rows	6
Number of Columns	10
PCB Mount Orientation	Vertical
Guide Location	Left

Electrical Characteristics

Impedance	100 Ω
Operating Voltage	30 VAC



Primary Product Color Contact Features Contact Mating Area Length PCB Contact Termination Area Plating Material Thickness Contact Layout Inline Contact Type Pin Contact Underplating Material Thickness I.27 µm[50 µin] Contact Mating Area Plating Material Thickness I.27 µm[50 µin] Contact Mating Area Plating Material Thickness Contact Mating Area Plating Material Thickness Contact Mating Area Plating Material Thickness Doula Beam Contact Shape & Form Dual Beam Contact Underplating Material PCB Contact Termination Area Plating Material Nickel PCB Contact Termination Area Plating Material Contact Underplating Material Contact Underplating Material PCB Contact Termination Area Plating Material Tin Contact Base Material Contact Current Rating (Max) Termination Features Termination Post & Tail Length Through Hole - Press-Fit	
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Guide Hardware Mating Retention Without	
Mating Retention Without	
PCB Mount Retention With	
PCB Mount Retention Type Action/Compliant Tail & Screw	
Mating Alignment With	
Mating Alignment Type Guide Pin	
Connector Mounting Type Board Mount	
Housing Features	

2

Number of Shrouded Sides



End Wall Location	Open
Housing Material	LCP - GF (Liquid Crystal Polymer)
Centerline (Pitch)	1.9 mm[.075 in]
Dimensions	
Connector Length	25.5 mm[1.004 in]
Connector Height	20.6 mm[.811 in]
Connector Width	12.7 mm[.5 in]
PCB Thickness (Recommended)	1 mm
PCB Hole Diameter	.39 mm[.015 in]
Row-to-Row Spacing	1.35 mm[.053 in]
Usage Conditions	
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
Compatible With Approved Standards Products	UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	Box & Tube, Tube

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not reviewed for solder process capability



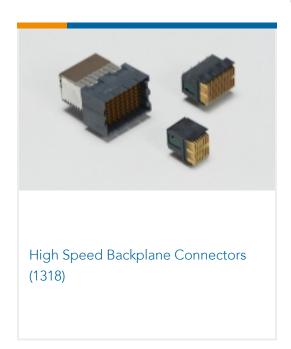
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | IMPACT



Customers Also Bought



















TE Part #1SNA118618R0100 FEM12

Documents

Product Drawings

IMP100S,H,V2P10C,LG,OEW39,4.9

English

CAD Files

Customer View Model

ENG_CVM_CVM_2057419-2_A.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2057419-2_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2057419-2_A.3d_stp.zip

English

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Product Specifications

Application Specification

English

Agency Approvals

Agency Approval Document

English